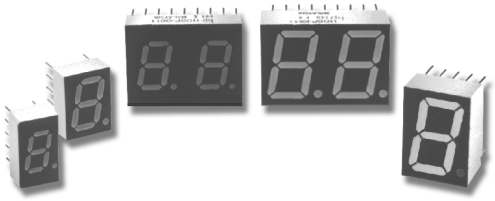
HDSP-Ax11

Black Surface Seven Segment Displays

Data Sheet



HDSP-AX11 / -AX13 Series, HDSP-FX11 / -FX13 Series
HDSP-GX11 / -GX13 Series, HDSP-HX11 / -HX13 Series
HDSP-KX11 / -KX13 Series

Description

These devices use industry standard size package and pinout. Available with black surface finish. All devices are available as either common anode or common cathode.

Typical applications include appliances, channel indicators of TV, CATV converters, game machines, and point of sale terminals.

Features

- **Black surface and color tinted epoxy**
- **Industry standard size**
- **Industry standard pinout**
- **Choice of character size**
  7.6 mm (0.30 in.), 10 mm (0.40 in.), 14.2 mm (0.56 in.)
- **Choice of colors**
  AlGaAs Red, High Efficiency Red (HER), Green, Orange
- **Excellent appearance**
  Evenly lighted segments
  ± 50° Viewing angle
- **Design flexibility**
  Common anode or common cathode
  Single and two digit
- **Categorized for luminous intensity**
  Categorized for color: Green
  Use of like categories yields a uniform display
- **Excellent for long digit string multiplexing**

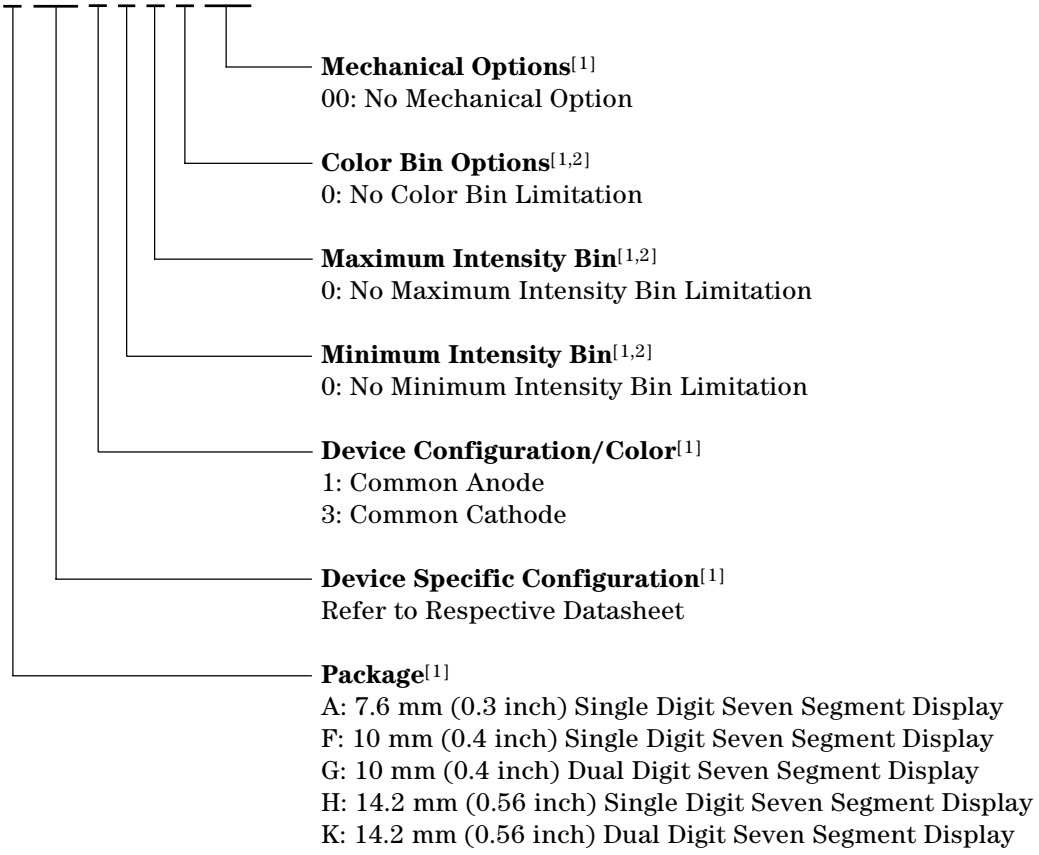
Devices

Orange HDSP-	AlGaAs Red HDSP-	HER HDSP-	Green HDSP-	Description	Package Drawing
A411	A111	A211	A511	7.6 mm Common Anode Right Hand Decimal	A
A413	A113	A213	A513	7.6 mm Common Cathode Right Hand Decimal	B
F411	F111	F211	F511	10 mm Common Anode Right Hand Decimal	C
F413	F113	F213	F513	10 mm Common Cathode Right Hand Decimal	D
G411	G111	G211	G511	10 mm Two Digit Common Anode Right Hand Decimal	E
G413	G113	G213	G513	10 mm Two Digit Common Cathode Right Hand Decimal	F
H411	H111	H211	H511	14.2 mm Common Anode Right Hand Decimal	G
H413	H113	H213	H513	14.2 mm Common Cathode Right Hand Decimal	H
K411	K111	K211	K511	14.2 mm Two Digit Common Anode Right Hand Decimal	I
K413	K113	K213	K513	14.2 mm Two Digit Common Cathode Right Hand Decimal	J

Part Numbering System

5082 - X X X X-X X X X X

HDSP-X X X X-X X X X X



Mechanical Options[1]
00: No Mechanical Option

Color Bin Options[1,2]
0: No Color Bin Limitation

Maximum Intensity Bin[1,2]
0: No Maximum Intensity Bin Limitation

Minimum Intensity Bin[1,2]
0: No Minimum Intensity Bin Limitation

Device Configuration/Color[1]
1: Common Anode
3: Common Cathode

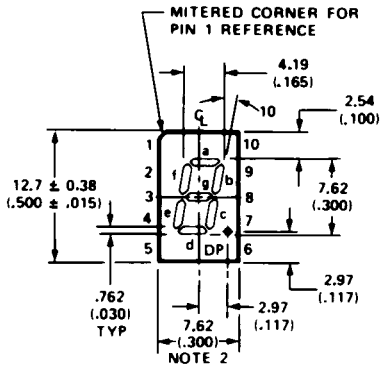
Device Specific Configuration[1]
Refer to Respective Datasheet

Package[1]
A: 7.6 mm (0.3 inch) Single Digit Seven Segment Display
F: 10 mm (0.4 inch) Single Digit Seven Segment Display
G: 10 mm (0.4 inch) Dual Digit Seven Segment Display
H: 14.2 mm (0.56 inch) Single Digit Seven Segment Display
K: 14.2 mm (0.56 inch) Dual Digit Seven Segment Display

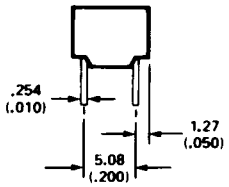
Notes:

1. For codes not listed in the figure above, please refer to the respective datasheet or contact your nearest Avago representative for details.
2. Bin options refer to shippable bins for a part number. Color and Intensity Bins are typically restricted to 1 bin per tube (exceptions may apply). Please refer to respective datasheet for specific bin limit information.

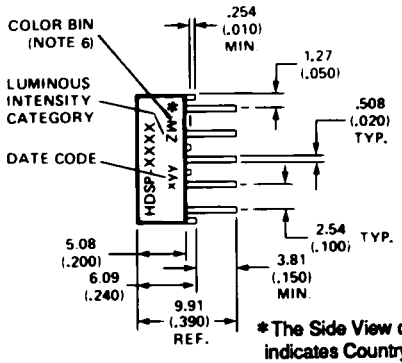
Package Dimensions (7.6 mm Series)



A, B



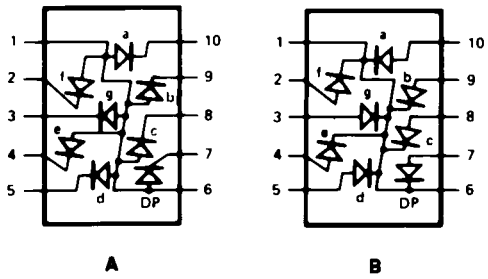
A, B



*The Side View of package indicates Country of Origin.

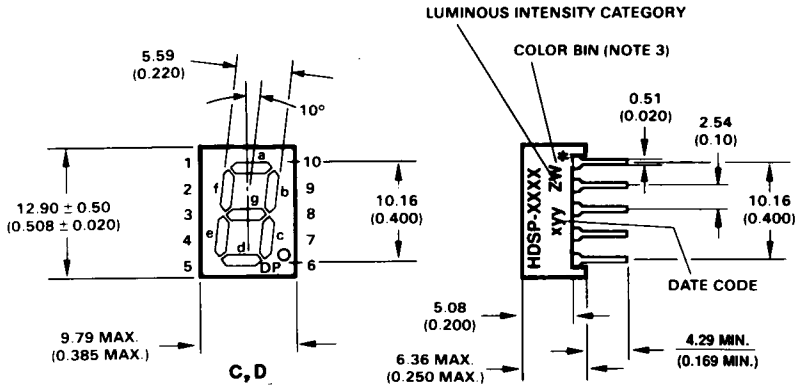
PIN	FUNCTION	
	A	B
1	ANODE[4]	CATHODE[5]
2	CATHODE f	ANODE f
3	CATHODE g	ANODE g
4	CATHODE e	ANODE e
5	CATHODE d	ANODE d
6	ANODE[4]	CATHODE[5]
7	CATHODE DP	ANODE DP
8	CATHODE c	ANODE c
9	CATHODE b	ANODE b
10	CATHODE a	ANODE a

Internal Circuit Diagram



NOTES:
1. ALL DIMENSIONS IN MILLIMETERS (INCHES).
2. MAXIMUM.
3. ALL UNTOLERANCED DIMENSIONS ARE FOR REFERENCE ONLY.
4. REDUNDANT ANODES.
5. REDUNDANT CATHODES.
6. FOR HDSP-A511/-A513 ONLY.

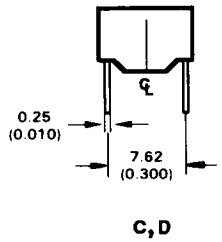
Package Dimensions (10 mm Series: Single)



C, D

C, D

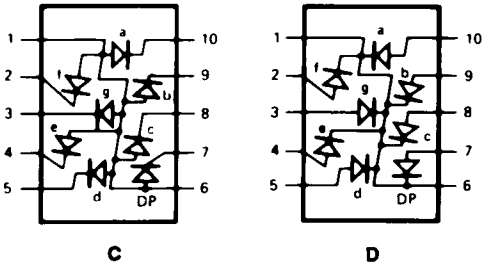
*The Side View of package indicates Country of Origin.



C, D

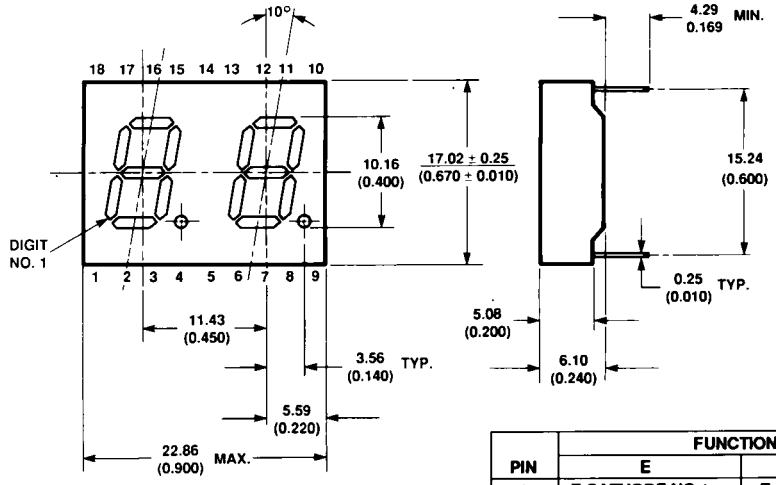
PIN	FUNCTION	
	C	D
1	ANODE[4]	CATHODE[5]
2	CATHODE f	ANODE f
3	CATHODE g	ANODE g
4	CATHODE e	ANODE e
5	CATHODE d	ANODE d
6	ANODE[4]	CATHODE[5]
7	CATHODE DP	ANODE DP
8	CATHODE c	ANODE c
9	CATHODE b	ANODE b
10	CATHODE a	ANODE a

Internal Circuit Diagram

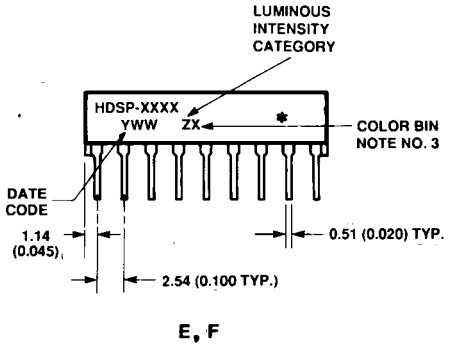


NOTES:
1. ALL DIMENSIONS IN MILLIMETERS (INCHES).
2. ALL UNTOLERANCED DIMENSIONS ARE FOR REFERENCE ONLY.
3. FOR HDSP-F511/-F513 ONLY.
4. REDUNDANT ANODES.
5. REDUNDANT CATHODES.

Package Dimensions (10 mm Series: Two Digit)



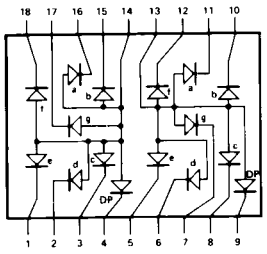
E, F



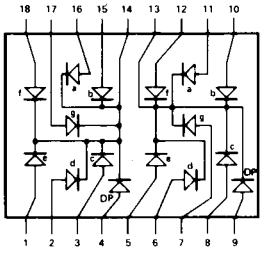
E, F

* The Side View of package indicates Country of Origin.

Internal Circuit Diagram



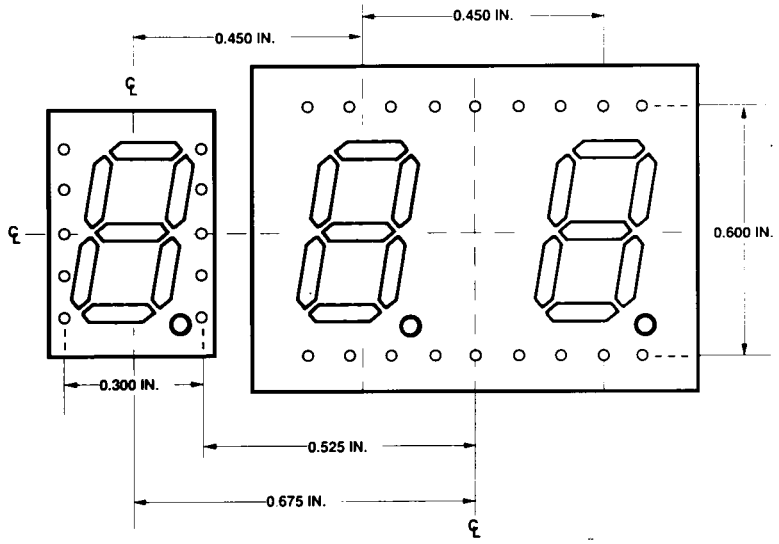
E



F

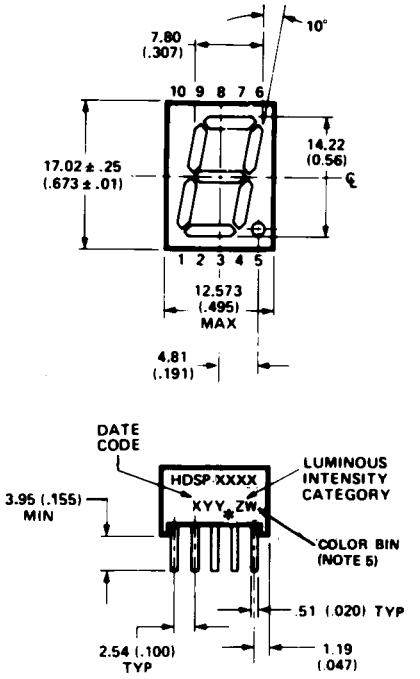
PIN	FUNCTION	
	E	F
1	E CATHODE NO 1	E ANODE NO. 1
2	D CATHODE NO. 1	D ANODE NO. 1
3	C CATHODE NO. 1	C ANODE NO. 1
4	DP CATHODE NO. 1	DP ANODE NO. 1
5	E CATHODE NO. 2	E ANODE NO. 2
6	D CATHODE NO. 2	D ANODE NO. 2
7	G CATHODE NO. 2	G ANODE NO. 2
8	C CATHODE NO. 2	C ANODE NO. 2
9	CP CATHODE NO. 2	DP ANODE NO. 2
10	B CATHODE NO. 2	B ANODE NO. 2
11	A CATHODE NO. 2	A ANODE NO. 2
12	F CATHODE NO. 2	F ANODE NO. 2
13	DIGIT NO. 2 ANODE	DIGIT NO. 2 CATHODE
14	DIGIT NO. 1 ANODE	DIGIT NO. 1 CATHODE
15	B CATHODE NO. 1	B ANODE NO. 1
16	A CATHODE NO. 2	A ANODE NO. 1
17	G CATHODE NO. 1	G ANODE NO. 1
18	F CATHODE NO. 1	F ANODE NO. 1

NOTES:
1. DIMENSIONS ARE IN MILLIMETERS (INCHES).
2. ALL UNTOLERANCED DIMENSIONS ARE FOR REFERENCE ONLY.
3. FOR HDSP-G511/-G513 ONLY.



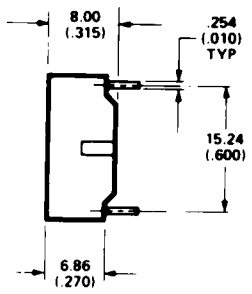
HOLE PATTERN FOR PCB LAYOUT TO ACHIEVE UNIFORM 0.450 DIGIT TO DIGIT PITCH. FOR HDSP-FXXX TO HDSP-GXXX.

Package Dimensions (14.2 mm Series: Single)



G, H

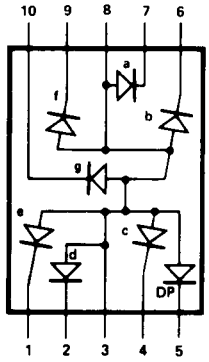
* The End View of package indicates Country of Origin.



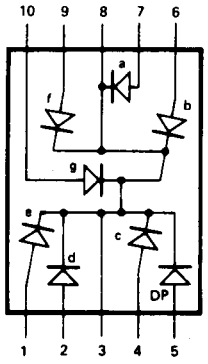
PIN	FUNCTION	
	G	H
1	CATHODE e	ANODE e
2	CATHODE d	ANODE d
3	ANODE[3]	CATHODE[4]
4	CATHODE c	ANODE c
5	CATHODE DP	ANODE DP
6	CATHODE b	ANODE b
7	CATHODE a	ANODE a
8	ANODE[3]	CATHODE[4]
9	CATHODE f	ANODE f
10	CATHODE g	ANODE g

NOTES:
1. ALL DIMENSIONS IN MILLIMETERS (INCHES).
2. ALL UNTOLERANCED DIMENSIONS ARE FOR REFERENCE ONLY.
3. REDUNDANT ANODES.
4. REDUNDANT CATHODES.
5. FOR HDSP-H511/-H513 ONLY.

Internal Circuit Diagram

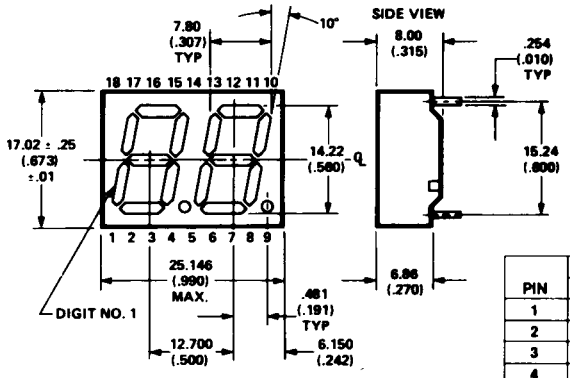


G

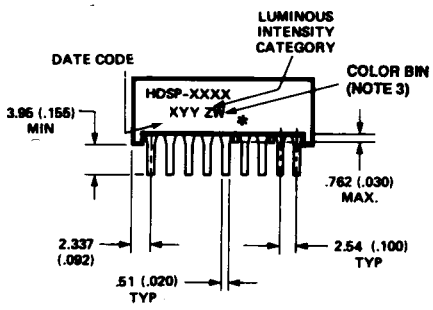


H

Package Dimensions (14.2 mm Series: Two Digit)



I, J



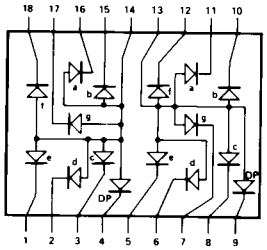
I, J

* The Side View of package indicates Country of Origin.

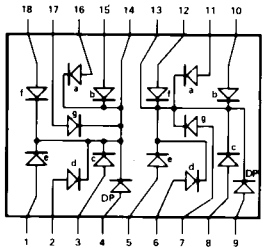
PIN	FUNCTION	
	I	J
1	E CATHODE NO 1	E ANODE NO. 1
2	D CATHODE NO. 1	D ANODE NO. 1
3	C CATHODE NO. 1	C ANODE NO. 1
4	DP CATHODE NO. 1	DP ANODE NO. 1
5	E CATHODE NO. 2	E ANODE NO. 2
6	D CATHODE NO. 2	D ANODE NO. 2
7	G CATHODE NO. 2	G ANODE NO. 2
8	C CATHODE NO. 2	C ANODE NO. 2
9	DP CATHODE NO. 2	DP ANODE NO. 2
10	B CATHODE NO. 2	B ANODE NO. 2
11	A CATHODE NO. 2	A ANODE NO. 2
12	F CATHODE NO. 2	F ANODE NO. 2
13	DIGIT NO. 2 ANODE	DIGIT NO. 2 CATHODE
14	DIGIT NO. 1 ANODE	DIGIT NO. 1 CATHODE
15	B CATHODE NO. 1	B ANODE NO. 1
16	A CATHODE NO. 1	A ANODE NO. 1
17	G CATHODE NO. 1	G ANODE NO. 1
18	F CATHODE NO. 1	F ANODE NO. 1

NOTES:
1. ALL DIMENSIONS IN MILLIMETERS (INCHES).
2. ALL UNTOLERANCED DIMENSIONS ARE FOR REFERENCE ONLY.
3. FOR HDSP-K511/-K513 ONLY.

Internal Circuit Diagram



I



J

Absolute Maximum Ratings

Description	AlGaAs Red HDSP-X11X Series	HER / Orange HDSP-X21X / X41X Series	Green HDSP-X51X Series	Units
Average Power per Segment or DP	37	105	105	mW
Peak Forward Current per Segment or DP	45	90[1]	90[3]	mA
DC Forward Current per Segment or DP	15[5]	30[2]	30[4]	mA
Operating Temperature Range	–20 to +100	–40 to +100		°C
Storage Temperature Range		–55 to +100		°C
Reverse Voltage per Segment or DP		3.0		V
Wave Soldering Temperature for 3 Seconds (1.60 mm [0.063 in.] below Body)		250		°C

Notes:
1. See Figure 5 to establish pulsed conditions.
2. Derate above 53°C at 0.45 mA / °C (see Figure 7).
3. See Figure 6 to establish pulsed conditions.
4. Derate above 39°C at 0.37 mA / °C (see Figure 7).
5. Derate above 91°C at 0.53 mA / °C (see Figure 1).

Electrical / Optical Characteristics at T_A = 25°C
AlGaAs Red

Device Series HDSP-	Parameter	Symbol	Min.	Typ.	Max.	Units	Test Conditions
A11X	Luminous Intensity / Segment[1,2] (Digit Average)	I_V	315	600		µcd	I_F = 1 mA
				3600			I_F = 5 mA
F11X, G11X			330	650			I_F = 1 mA
				3900			I_F = 5 mA
H11X, K11X			400	700			I_F = 1 mA
				4200			I_F = 5 mA
All Devices	Forward Voltage / Segment or DP	V_F		1.6	2.0	V	I_F = 1 mA
				1.7			I_F = 5 mA
				1.8	22		I_F = 20 mA Peak
	Peak Wavelength	λ_{PEAK}		645		nm	
	Dominant Wavelength[3]	λ_d		637		nm	
	Reverse Voltage / Segment or DP[4]	V_R	3.0	15		V	I_R = 100 µA
	Temperature Coefficient of V_F / Segment or DP	ΔV_F / °C		-2		mV / °C	
A11X	Thermal Resistance LED Junction-to-Pin	$R\theta_{J\text{-}PIN}$		255		°C / W / Seg.	
F11X, G11X				320			
H11X, K12X				400			

Orange

Device Series HDSP-	Parameter	Symbol	Min.	Typ.	Max.	Units	Test Conditions
A41X	Luminous Intensity / Segment (Segment Average)[1,2]	I_V		0.70		mcd	I_F = 5 mA
F41X, G41X				1.0			I_F = 5 mA
H41X, K41X				2.37			I_F = 10 mA
All Devices	Forward Voltage / Segment or DP	V_F		2.0	2.5	V	I_F = 20 mA
	Peak Wavelength	λ_{PEAK}		600		nm	
	Dominant Wavelength[3]	λ_d		603		nm	
	Reverse Voltage / Segment or DP[4]	V_R	3.0	30		V	I_R = 100 µA
	Temperature Coefficient of V_F / Segment or DP	ΔV_F / °C		–2		mV / °C	
A41X	Thermal Resistance LED Junction-to-Pin	$R\theta_{J\text{-}PIN}$		200		°C / W / Seg.	
F41X, G41X				320			
H41X, K41X				345			

High Efficiency Red

Device Series HDSP-	Parameter	Symbol	Min.	Typ.	Max.	Units	Test Conditions
A21X	Luminous Intensity / Segment[1,2] (Digit Average)	I_V	360	980		µcd	I_F = 5 mA
				5390			I_F = 20 mA
F21X, G21X			420	1200			I_F = 5 mA
H21X, K21X			900	2800			I_F = 10 mA
				3700			I_F = 60 mA Peak: 1 / 6 Duty Factor
All Devices	Forward Voltage / Segment or DP	V_F		2.0	2.5	V	I_F = 20 mA
	Peak Wavelength	λ_{PEAK}		635		nm	
	Dominant Wavelength[3]	λ_d		626		nm	
	Reverse Voltage / Segment or DP[4]	V_R	3.0	30		V	I_R = 100 µA
	Temperature Coefficient of V_F / Segment or DP	ΔV_F / °C		-2		mV / °C	
A21X	Thermal Resistance LED Junction-to-Pin	$R\theta_{J\text{-}PIN}$		200		°C / W / Seg.	
F21X, G21X				320			
H21X, K21X				345			

High Performance Green

Device Series HDSP-	Parameter	Symbol	Min.	Typ.	Max.	Units	Test Conditions
A51X	Luminous Intensity / Segment[1,2] (Digit Average)	I_V	860	3000		µcd	I_F = 10 mA
				6800			I_F = 20 mA
F51X, G51X			1030	3500			I_F = 10 mA
H51X, K51X			900	2500			I_F = 10 mA
				3100			I_F = 60 mA Peak: 1/6 Duty Factor
All Devices	Forward Voltage / Segment or DP	V_F		2.1	2.5	V	I_F = 10 mA
	Peak Wavelength	λ_{PEAK}		566		nm	
	Dominant Wavelength[3,5]	λ_d		571	577	nm	
	Reverse Voltage / Segment or DP[4]	V_R	3.0	50		V	I_R = 100 µA
	Temperature Coefficient of	ΔV_F / °C		-2		mV / °C	
	V_F / Segment or DP						
A51X	Thermal Resistance LED Junction-to-Pin	$R\theta_{J\text{-}PIN}$		200		°C / W / Seg.	
F51X, G51X				320			
H51X, K51X				345			

Notes:

1. Case temperature of device immediately prior to the intensity measurement is 25°C.
2. The digits are categorized for luminous intensity. The intensity category is designated by a letter on the side of the package.
3. The dominant wavelength, λ_d, is derived from the CIE chromaticity diagram and is that single wavelength which defines the color of the device.
4. Typical specification for reference only. Do not exceed absolute maximum ratings.
5. Green (HDSP-A51X / F51X / G51X / H512X / K51X) series displays are categorized for dominant wavelength. The category is designated by a number adjacent to the luminous intensity category letter.

AlGaAs Red

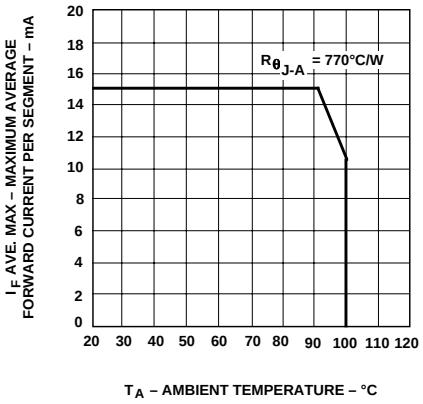


Figure 1. Maximum allowable average or dc current vs. ambient temperature.

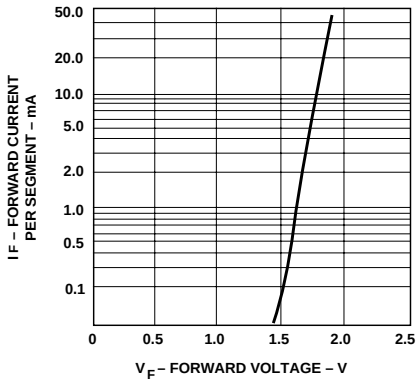


Figure 2. Forward current vs. forward voltage.

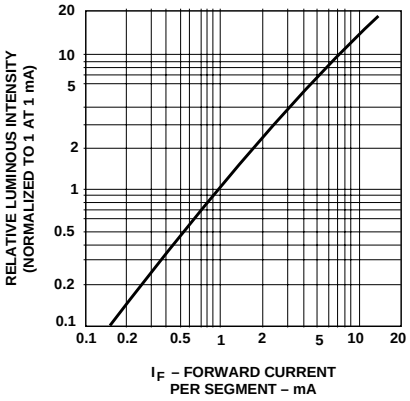


Figure 3. Relative luminous intensity vs. dc forward current.

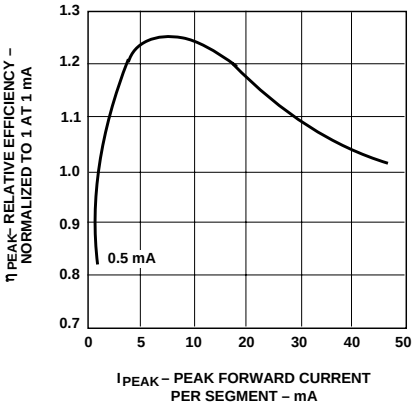


Figure 4. Relative efficiency (luminous intensity per unit current) vs. peak current.

HER, Green, Orange

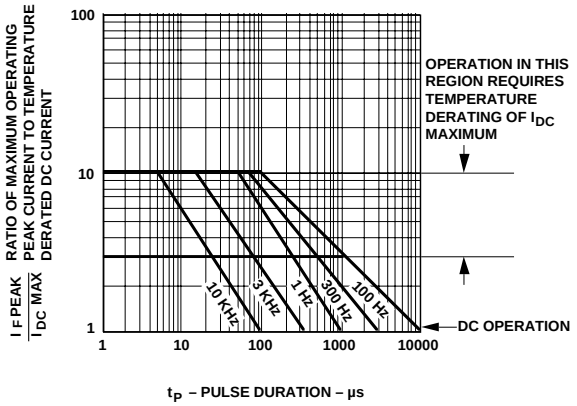


Figure 5. Maximum tolerable peak current vs. pulse duration – HER, Orange.

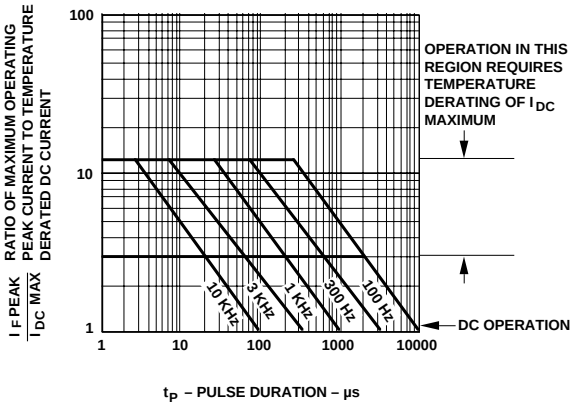


Figure 6. Maximum tolerable peak current vs. pulse duration – Green.

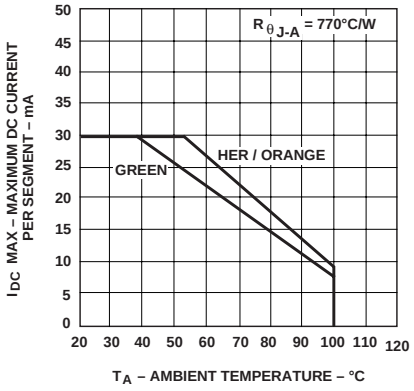


Figure 7. Maximum allowable dc current vs. ambient temperature.

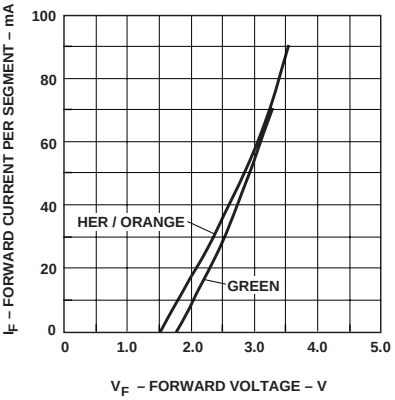


Figure 8. Forward current vs. forward voltage characteristics.

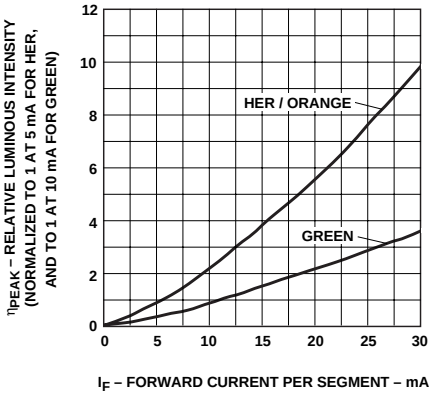


Figure 9. Relative luminous intensity vs. dc forward current.

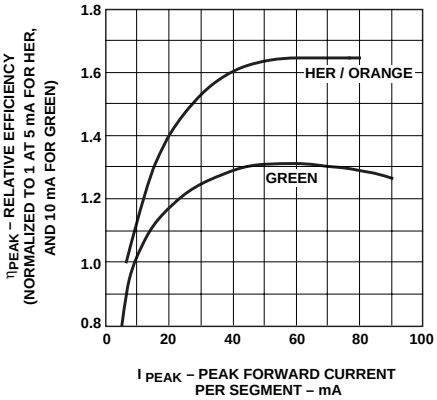


Figure 10. Relative efficiency (luminous intensity per unit current) vs. peak current.

Intensity Bin Limits (mcd)
AlGaAs Red

HDSP-A1xx

IV Bin Category	Min.	Max.
E	0.315	0.520
F	0.428	0.759
G	0.621	1.16
H	0.945	1.71
I	1.40	2.56
J	2.10	3.84
K	3.14	5.75
L	4.70	8.55

HDSP-F1xx / G1xx

IV Bin Category	Min.	Max.
D	0.391	0.650
E	0.532	0.923
F	0.755	1.39
G	1.13	2.08
H	1.70	3.14

HDSP-H1xx / K1xx

IV Bin Category	Min.	Max.
C	0.415	0.690
D	0.565	0.990
E	0.810	1.50
F	1.20	2.20
G	1.80	3.30
H	2.73	5.00
I	4.09	7.50

Orange

HDSP-A41X

IV Bin Category	Min	Max
A	0.284	0.433
B	0.354	0.541
C	0.443	0.677
D	0.554	0.846
E	0.692	1.057
F	0.856	1.322
G	1.082	1.652
H	1.352	2.066
I	1.692	2.581
J	2.114	3.227
K	2.641	4.034
L	3.300	5.042
M	4.127	6.303
N	5.157	7.878

HDSP-F41X / G41X

IV Bin Category	Min	Max
C	0.485	0.890
D	0.728	1.333
E	1.091	2.000
F	1.636	3.000
G	2.454	4.500
H	3.682	6.751

HDSP-H41X / K41X

IV Bin Category	Min	Max
B	0.77	1.17
C	0.95	1.45
D	1.19	1.82
E	1.49	2.27
F	1.85	2.89
G	2.32	3.54
H	2.90	4.43

Intensity Bin Limits (mcd), continued
HER

HDSP-A2xx		
IV Bin Category	**Min.**	**Max.**
B	0.342	0.630
C	0.516	0.946
D	0.774	1.418
E	1.160	2.127
F	1.740	3.190
G	2.610	4.785
H	3.915	7.177

HDSP-F2xx / G2xx		
IV Bin Category	**Min.**	**Max.**
C	0.485	0.890
D	0.728	1.333
E	1.091	2.000
F	1.636	3.000
G	2.454	4.500
H	3.682	6.751

HDSP-H2xx / K2xx		
IV Bin Category	**Min.**	**Max.**
E	0.91	1.67
F	1.37	2.51
G	2.05	3.76
H	3.08	5.64
I	4.62	8.64
J	6.93	12.70
K	10.39	19.04

Intensity Bin Limits (mcd), continued
Green

HDSP-A5xx

IV Bin Category	Min.	Max.
H	0.86	1.58
I	1.29	2.37
J	1.94	3.55
K	2.90	5.33
L	4.37	8.01

HDSP-F5xx / G5xx

IV Bin Category	Min.	Max.
H	1.54	2.82
I	2.31	4.23
J	3.46	6.34
K	5.18	9.50
L	7.78	14.26

HDSP-H5xx / K5xx

IV Bin Category	Min.	Max.
E	0.91	1.67
F	1.37	2.51
G	2.05	3.76
H	3.08	5.64
I	4.61	8.46

Color Categories

		Dominant Wavelength (nm)	
Color	**Bin**	**Min.**	**Max.**
Green	2	573.00	577.00
	3	570.00	574.00
	4	567.00	571.00
	5	564.00	568.00

Note:
All categories are established for classification of products. Products may not be available in all categories. Please contact your Avago representatives for further clarification / information.

Contrast Enhancement

For information on contrast enhancement, please see Application Note 1015.

Soldering / Cleaning

For information on soldering LEDs, please refer to Application Note 1029.

Electrical / Optical

For more information on electrical/optical characteristics, please see Application Note 1005.

For product information and a complete list of distributors, please go to our website: **www.avagotech.com**

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5989-2795EN April 10, 2006

AVAGO TECHNOLOGIES

LifeElectronics
Живое партнерство

ООО «ЛайфЭлектроникс» **“LifeElectronics” LLC**

ИНН 7805602321 КПП 780501001 Р/С 40702810122510004610 ФАКБ "АБСОЛЮТ БАНК" (ЗАО) в г.Санкт-Петербурге К/С 30101810900000000703 БИК 044030703

Компания «Life Electronics» занимается поставками электронных компонентов импортного и отечественного производства от производителей и со складов крупных дистрибьюторов Европы, Америки и Азии.

С конца 2013 года компания активно расширяет линейку поставок компонентов по направлению коаксиальный кабель, кварцевые генераторы и конденсаторы (керамические, пленочные, электролитические), за счёт заключения дистрибьюторских договоров

Мы предлагаем:

- *Конкурентоспособные цены и скидки постоянным клиентам.*
- *Специальные условия для постоянных клиентов.*
- *Подбор аналогов.*
- *Поставку компонентов в любых объемах, удовлетворяющих вашим потребностям.*

- *Приемлемые сроки поставки, возможна ускоренная поставка.*
- *Доставку товара в любую точку России и стран СНГ.*
- *Комплексную поставку.*
- *Работу по проектам и поставку образцов.*
- *Формирование склада под заказчика.*

- *Сертификаты соответствия на поставляемую продукцию (по желанию клиента).*
- *Тестирование поставляемой продукции.*
- *Поставку компонентов, требующих военную и космическую приемку.*
- *Входной контроль качества.*
- *Наличие сертификата ISO.*

В составе нашей компании организован Конструкторский отдел, призванный помогать разработчикам, и инженерам.

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- *Регистрацию проекта у производителя компонентов.*
- *Техническую поддержку проекта.*
- *Защиту от снятия компонента с производства.*
- *Оценку стоимости проекта по компонентам.*
- *Изготовление тестовой платы монтаж и пусконаладочные работы.*

Тел: +7 (812) 336 43 04 (многоканальный)
Email: org@lifeelectronics.ru

www.lifeelectronics.ru